

Abstract

The invention concerns a security element (2) for RF identification and a process for the production of such a security element. The security element has a flexible, electrically non-conducting substrate layer (24) and a conductive layer (29) of an electrically conducting material which is applied to the substrate layer and which in a first surface region of the substrate layer is shaped out in pattern form to form an RF component. A first relief structure (27) is shaped at least in region-wise manner in the surface region, associated with the RF component, in the first conductive layer (29).

(Figure 2a)